

IPB90N06S4L-04-VB Datasheet

N-Channel 60 V (D-S) MOSFET

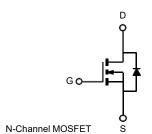
PRODUCT SUMMARY				
V _{DS}	60	V		
$R_{DS(on)}V_{GS} = 10 V$	4	mΩ		
ID	150	Α		
Configuration	Single			

FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- 100 % R_g and UIS tested







ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unless o	otherwise noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	60	V
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current	T _C = 25 °C ^a	ı	150	
Continuous Drain Current	T _C = 125 °C	l _D	65	
Continuous Source Current (Diode Conduction)	а	ls	120	Α
Pulsed Drain Current ^b		I_{DM}	350	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	65	
Single Pulse Avalanche Energy	L = 0.11IIII	E _{AS}	211	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	Pp	220	W
waxiiiidiii Fowei Dissipatioii =	T _C = 125 °C	гD	70	V V
Operating Junction and Storage Temperature R	Range	T_J , T_{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.65	C/VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).

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PARAMETER	SYMBOL	rwise noted) TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA		60	-	-	.,	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2.0		4.0	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA	
		V _{GS} = 0 V	V _{DS} = 60 V	-	-	1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 60 V, T _J = 125 °C	-	-	50	μA	
		V _{GS} = 0 V	V _{DS} = 60 V, T _J = 175 °C	-	-	250	† '	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	120	-	-	Α	
		V _{GS} = 10 V	I _D = 30 A	-	4	-		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A, T _J = 125 °C	-	12	-	mΩ	
		V _{GS} = 10 V	I _D = 30 A, T _J = 175 °C	-	15	-		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		-	94	-	S	
Dynamic ^b	·	<u> </u>						
Input Capacitance	C _{iss}			-	-	7000		
Output Capacitance	C _{oss}	V _{GS} = 0 V	V V _{DS} = 25 V, f = 1 MHz		-	715	pF	
Reverse Transfer Capacitance	C _{rss}				-	360		
Total Gate Charge ^c	Qg			-	96	145		
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V	$V_{DS} = 30 \text{ V}, I_{D} = 75 \text{ A}$	-	24	-	nC	
Gate-Drain Charge ^c	Q_{gd}			-	27	-	1	
Gate Resistance	Rg	f = 1 MHz		0.3	1	1.7	Ω	
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = 30 \text{ V, } R_L = 0.4 \Omega$ $I_D \cong 75 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$		-	16	24		
Rise Time ^c	t _r			-	14	21	- ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	34	51		
Fall Time ^c	t _f			-	9	14		
Source-Drain Diode Ratings and Chara	cteristics ^b	<u> </u>						
Pulsed Current ^a	I _{SM}			-	-	450	Α	
Forward Voltage	V _{SD}	I _F = 75 A, V _{GS} = 0		-	0.9	1.5	V	

Notes

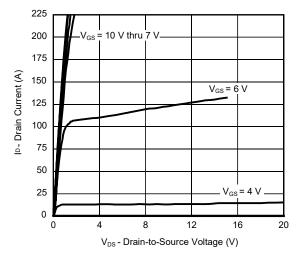
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$ b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

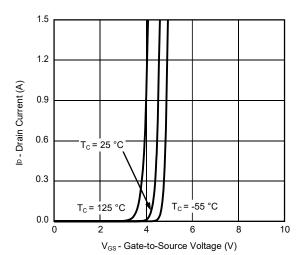
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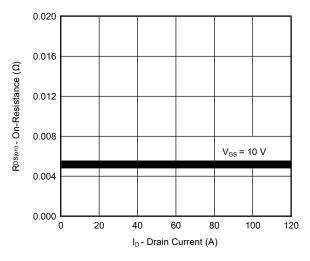
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



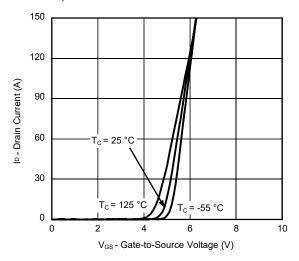
Output Characteristics



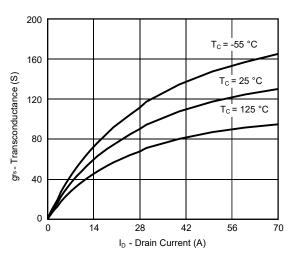
Transfer Characteristics



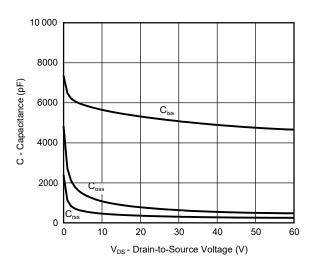
On-Resistance vs. Drain Current



Transfer Characteristics



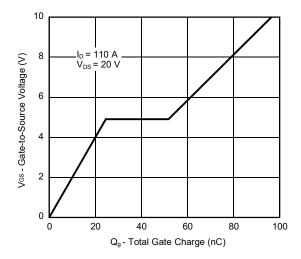
Transconductance



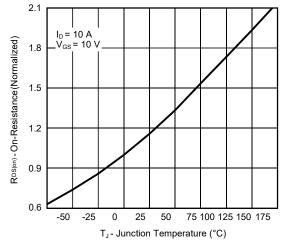
Capacitance



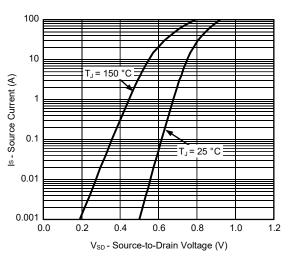
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



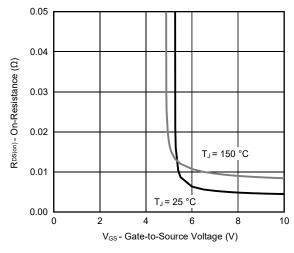
Gate Charge



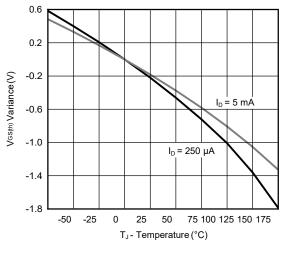
On-Resistance vs. Junction Temperature



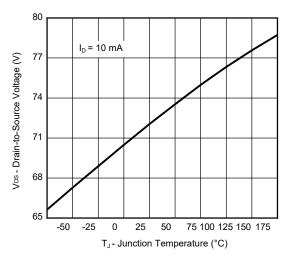
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



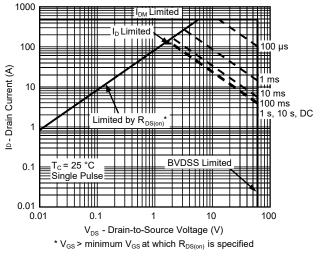
Threshold Voltage



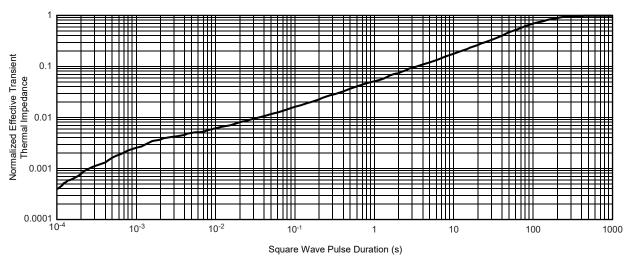
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area

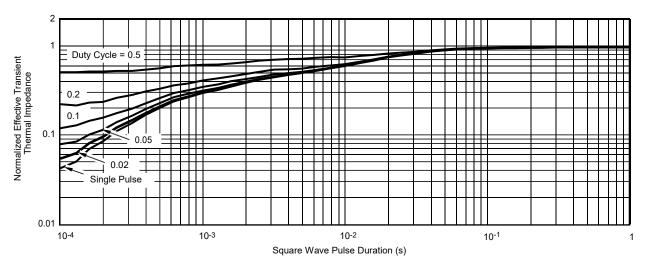


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

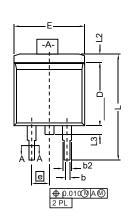
Note

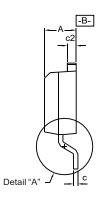
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

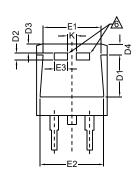
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



TO-263 (D²PAK): 3-LEAD

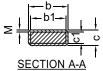








DETAIL A (ROTATED 90°)



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	C.	CTION	1	Ť

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

 This feature is for thick lead.

		INCHES		MILLIN	METERS
DIM.		MIN.	MAX.	MIN.	MAX.
Α		0.160	0.190	4.064	4.826
	b	0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
c*	Thin lead	0.013	0.018	0.330	0.457
	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
61	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
D4		0.044	0.052	1.118	1.321
Е		0.380	0.410	9.652	10.414
E1		0.245	-	6.223	-
E2				9.017	9.525
E3		0.072	0.078	1.829	1.981
е		0.100 BSC		2.54 BSC	
K		0.045	0.055	1.143	1.397
L		0.575	0.625	14.605	15.875
L1		0.090	0.110	2.286	2.794
L2		0.040	0.055	1.016	1.397
L3		0.050	0.070	1.270	1.778
L4		0.010	BSC	0.254 BSC	
M		-	0.002	-	0.050
ECN: T13-0707-Rev. K. 30-Sep-13					

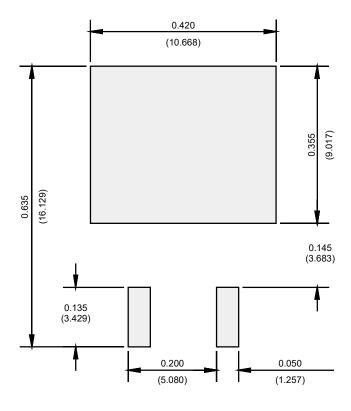
ECN: T13-0707-Rev. K, 30-Sep-13

DWG: 5843

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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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